

Sample &

Buv



#### LM7171

SNOS760C - MAY 1999-REVISED SEPTEMBER 2014

# LM7171 Very High Speed, High Output Current, Voltage Feedback Amplifier

Technical

Documents

#### Features 1

- (Typical Unless Otherwise Noted)
- Easy-to-Use Voltage Feedback Topology
- Very High Slew Rate: 4100 V/µs
- Wide Unity-Gain Bandwidth: 200 MHz
- -3 dB Frequency @ A<sub>V</sub> = +2: 220 MHz
- Low Supply Current: 6.5 mA
- High Open Loop Gain: 85 dB
- High Output Current: 100 mA
- Differential Gain and Phase: 0.01%, 0.02°
- Specified for ±15V and ±5V Operation

#### Applications 2

- HDSL and ADSL Drivers
- Multimedia Broadcast Systems
- **Professional Video Cameras**
- Video Amplifiers
- Copiers/Scanners/Fax
- **HDTV** Amplifiers
- Pulse Amplifiers and Peak Detectors
- CATV/Fiber Optics Signal Processing

# 3 Description

Tools &

Software

The LM7171 is a high speed voltage feedback amplifier that has the slewing characteristic of a current feedback amplifier, yet it can be used in all traditional voltage feedback amplifier configurations. The LM7171 is stable for gains as low as +2 or -1. It provides a very high slew rate at 4100V/µs and a wide unity-gain bandwidth of 200 MHz while consuming only 6.5 mA of supply current. It is ideal for video and high speed signal processing applications such as HDSL and pulse amplifiers. With 100 mA output current, the LM7171 can be used for video distribution, as a transformer driver or as a laser diode driver.

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Operation on ±15 V power supplies allows for large signal swings and provides greater dynamic range and signal-to-noise ratio. The LM7171 offers low SFDR and THD, ideal for ADC/DAC systems. In addition, the LM7171 is specified for ±5 V operation for portable applications.

The LM7171 is built on TI's advanced VIP™ III (Vertically integrated PNP) complementary bipolar process.

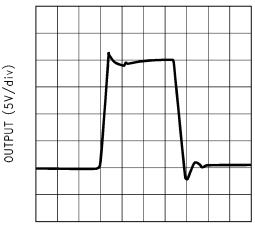
| PART NUMBER | PACKAGE  | BODY SIZE (NOM)   |
|-------------|----------|-------------------|
| LM7171      | SOIC (8) | 4.90 mm × 3.91 mm |
| LM7171      | PDIP (8) | 9.81 mm × 6.35 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

# 04 v 0/P BUFFER Q3

Note: M1 and M2 are current mirrors.

## Large Signal Pulse Response $A_V = +2, V_S = \pm 15V$



TIME (20 ns/div)

# Simplified Schematic Diagram



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# **4** Revision History

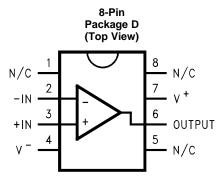
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| C | hanges from Revision B (March 2013) to Revision C  | Page |
|---|--|------|
| • | Changed data sheet flow and layout to conform with new TI standards. Added the following sections: Device Information Table, Application and Implementation; Layout; Device and Documentation Support; Mechanical, Packaging, and Ordering Information | 1    |
| • | Changed "Junction Temperature Range" to " Operating Temperature Range" and deleted T <sub>J</sub>  | 4    |
| • | Deleted T <sub>J</sub> = 25°C for Electrical Characteristics tables  | 5    |
| C | hanges from Revision A (March 2013) to Revision B  | Page |



## LM7171 SNOS760C – MAY 1999–REVISED SEPTEMBER 2014

# 5 Pin Configuration and Functions



## **Pin Functions**

| PIN    |     | I/O | DESCRIPTION                |  |
|--------|-----|-----|----------------------------|--|
| NAME   | NO. | 1/0 | DESCRIPTION                |  |
| N/C    | 1   | -   | No Connection              |  |
| -IN    | 2   | I   | Inverting Power Supply     |  |
| +IN    | 3   | I   | Non-inverting Power Supply |  |
| V-     | 4   | I   | Supply Voltage             |  |
| N/C    | 5   | -   | No Connection              |  |
| OUTPUT | 6   | 0   | Output                     |  |
| V+     | 7   | I   | Supply Voltage             |  |
| N/C    | 8   | -   | No Connection              |  |

# 6 Specifications

# 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|  | MIN MAX    | UNIT |
|--|------------|------|
| Supply Voltage (V <sup>+</sup> –V <sup>-</sup> ) | 36         | V    |
| Differential Input Voltage <sup>(2)</sup>        | ±10        | V    |
| Output Short Circuit to Ground <sup>(3)</sup>    | Continuous |      |
| Maximum Junction Temperature <sup>(4)</sup>      | 150        | °C   |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Input differential voltage is applied at  $V_S = \pm 15V$ .

(3) Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C.

(4) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $R_{\theta JA}$ , and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(MAX)} - T_A)/R_{\theta JA}$ . All numbers apply for packages soldered directly into a PC board.

# 6.2 Handling Ratings

|                    |  |  | MIN | MAX  | UNIT |
|--------------------|--|--|-----|------|------|
| T <sub>stg</sub>   | Storage temperature rang               | e  | -65 | +150 | °C   |
| V <sub>(ESD)</sub> | Electrostatic discharge <sup>(1)</sup> | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all $pins^{(2)}$ |     | 2500 | V    |

(1) Human body model, 1.5 k $\Omega$  in series with 100 pF.

(2) JEDEC document JEP155 states that 2500-V HBM allows safe manufacturing with a standard ESD control process.

# 6.3 Recommended Operating Conditions<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|   | MIN                   | TYP MAX | UNIT |
|---|-----------------------|---------|------|
| Supply Voltage                                  | $5.5V \le V_S \le 36$ |         | V    |
| Operating Temperature Range: LM7171AI, LM7171BI | -40                   | +85     | °C   |

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not specified. For ensured specifications and the test conditions, see the Electrical Characteristics.

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | P (PDIP) | D (SOIC) | UNIT |
|-------------------------------|--|----------|----------|------|
|                               |  | 8 PINS   | 8 PINS   | UNIT |
| $R_{\thetaJA}$                | Junction-to-ambient thermal resistance | 108°     | 172°     | °C/W |

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.



# 6.5 ±15V DC Electrical Characteristics

Unless otherwise noted, all limits are specified for V<sup>+</sup> = +15 V, V<sup>-</sup> = -15 V, V<sub>CM</sub> = 0V, and R<sub>L</sub> = 1 k $\Omega$ . **Boldface** limits apply at the temperature extremes

|                    | PARAMETER                                | TEST CONDITIONS               | <b>TYP</b><br>(1) | LM7171AI<br>LIMIT <sup>(2)</sup> | LM7171BI<br>LIMIT <sup>(2)</sup> | UNIT  |
|--------------------|--|-------------------------------|-------------------|----------------------------------|----------------------------------|-------|
| V <sub>OS</sub>    | Input Offset Voltage                     |                               | 0.2               | 1                                | 3                                | mV    |
|                    |  |                               |                   | 4                                | 7                                | max   |
| TC V <sub>OS</sub> | Input Offset Voltage Average<br>Drift    |                               | 35                |                                  |                                  | µV/°C |
| I <sub>B</sub>     | Input Bias Current                       |                               | 2.7               | 10                               | 10                               | μA    |
|                    |  |                               |                   | 12                               | 12                               | max   |
| OS                 | Input Offset Current                     |                               | 0.1               | 4                                | 4                                | μA    |
|                    |  |                               |                   | 6                                | 6                                | max   |
| R <sub>IN</sub>    | Input Resistance                         | Common Mode                   | 40                |                                  |                                  | MΩ    |
|                    |  | Differential Mode             | 3.3               |                                  |                                  |       |
| Ro                 | Open Loop Output<br>Resistance           |                               | 15                |                                  |                                  | Ω     |
| CMRR               | Common Mode Rejection                    | $V_{CM} = \pm 10V$            | 105               | 85                               | 75                               | dB    |
|                    | Ratio                                    |                               |                   | 80                               | 70                               | min   |
| PSRR               | Power Supply Rejection Ratio             | $V_{S} = \pm 15V$ to $\pm 5V$ | 90                | 85                               | 75                               | dB    |
|                    |  |                               |                   | 80                               | 70                               | min   |
| / <sub>СМ</sub>    | Input Common-Mode Voltage<br>Range       | CMRR > 60 dB                  | ±13.35            |                                  |                                  | V     |
| ۹v                 | Large Signal Voltage Gain <sup>(3)</sup> | $R_L = 1 \ k\Omega$           | 85                | 80                               | 75                               | dB    |
|                    |  |                               |                   | 75                               | 70                               | min   |
|                    |  | R <sub>L</sub> = 100Ω         | 81                | 75                               | 70                               | dB    |
|                    |  |                               |                   | 70                               | 66                               | min   |
| / <sub>0</sub>     | Output Swing                             | $R_L = 1 \ k\Omega$           | 13.3              | 13                               | 13                               | V     |
|                    |  |                               |                   | 12.7                             | 12.7                             | min   |
|                    |  |                               | -13.2             | -13                              | -13                              | V     |
|                    |  |                               |                   | -12.7                            | -12.7                            | max   |
|                    |  | R <sub>L</sub> = 100Ω         | 11.8              | 10.5                             | 10.5                             | V     |
|                    |  |                               |                   | 9.5                              | 9.5                              | min   |
|                    |  |                               | -10.5             | -9.5                             | -9.5                             | V     |
|                    |  |                               |                   | -9                               | -9                               | max   |
|                    | Output Current (Open Loop)               | Sourcing, $R_L = 100\Omega$   | 118               | 105                              | 105                              | mA    |
|                    | (4)                                      |                               |                   | 95                               | 95                               | min   |
|                    |  | Sinking, $R_L = 100\Omega$    | 105               | 95                               | 95                               | mA    |
|                    |  |                               |                   | 90                               | 90                               | max   |
|                    | Output Current (in Linear                | Sourcing, $R_L = 100\Omega$   | 100               |                                  |                                  | mA    |
|                    | Region)                                  | Sinking, $R_L = 100\Omega$    | 100               |                                  |                                  |       |
| SC                 | Output Short Circuit Current             | Sourcing                      | 140               |                                  |                                  | mA    |
|                    | ·  | Sinking                       | 135               |                                  |                                  |       |
| S                  | Supply Current                           | -                             | 6.5               | 8.5                              | 8.5                              | mA    |
| -                  |  |                               |                   | 9.5                              | 9.5                              | max   |

(1) Typical values represent the most likely parametric norm.

(2) All limits are specified by testing or statistical analysis.

(3) Large signal voltage gain is the total output swing divided by the input signal required to produce that swing. For  $V_S = \pm 15V$ ,  $V_{OUT} = \pm 5V$ . For  $V_S = \pm 5V$ ,  $V_{OUT} = \pm 1V$ .

(4) The open loop output current is specified, by the measurement of the open loop output voltage swing, using  $100\Omega$  output load.

# 6.6 ±15V AC Electrical Characteristics

Unless otherwise noted, all limits are specified for V<sup>+</sup> = +15V, V<sup>-</sup> = -15V, V<sub>CM</sub> = 0V, and R<sub>L</sub> = 1 k $\Omega$ .

|                | PARAMETER                                 | CONDITIONS   | TYP <sup>(1)</sup> | LM7171AI<br>LIMIT <sup>(2)</sup> | LM7171BI<br>LIMIT <sup>(2)</sup> | UNIT               |
|----------------|---|--|--------------------|----------------------------------|----------------------------------|--------------------|
| SR             | Slew Rate <sup>(3)</sup>                  | $A_V = +2, V_{IN} = 13 V_{PP}$   | 4100               |                                  |                                  | V/µs               |
|                |   | $A_V$ = +2, $V_{IN}$ = 10 $V_{PP}$   | 3100               |                                  |                                  |                    |
|                | Unity-Gain Bandwidth                      |  | 200                |                                  |                                  | MHz                |
|                | -3 dB Frequency                           | A <sub>V</sub> = +2  | 220                |                                  |                                  | MHz                |
| φ <sub>m</sub> | Phase Margin                              |  | 50                 |                                  |                                  | Deg                |
| t <sub>s</sub> | Settling Time (0.1%)                      | $\begin{array}{l} A_{V} = -1, \ V_{O} = \pm 5V \\ R_{L} = 500\Omega \end{array}$ | 42                 |                                  |                                  | ns                 |
| tp             | Propagation Delay                         | $\begin{array}{l} A_{V}=-2, \ V_{IN}=\pm 5V,\\ R_{L}=500\Omega \end{array}$      | 5                  |                                  |                                  | ns                 |
| A <sub>D</sub> | Differential Gain (4)                     |  | 0.01%              |                                  |                                  |                    |
| φ <sub>D</sub> | Differential Phase (4)                    |  | 0.02               |                                  |                                  | Deg                |
|                | Second Harmonic Distortion <sup>(5)</sup> | f <sub>IN</sub> = 10 kHz   | -110               |                                  |                                  | dBc                |
|                |   | f <sub>IN</sub> = 5 MHz  | -75                |                                  |                                  | dBc                |
|                | Third Harmonic Distortion <sup>(5)</sup>  | f <sub>IN</sub> = 10 kHz   | -115               |                                  |                                  | dBc                |
|                |   | f <sub>IN</sub> = 5 MHz  | -55                |                                  |                                  | dBc                |
| e <sub>n</sub> | Input-Referred Voltage Noise              | f = 10 kHz   | 14                 |                                  |                                  | nV/√Hz             |
| i <sub>n</sub> | Input-Referred Current Noise              | f = 10 kHz   | 1.5                |                                  |                                  | pA/√ <del>Hz</del> |

Typical values represent the most likely parametric norm.
 All limits are specified by testing or statistical analysis.
 Slew Rate is the average of the raising and falling slew rates.
 Differential gain and phase are measured with A<sub>V</sub> = +2, V<sub>IN</sub> = 1 V<sub>PP</sub> at 3.58 MHz and both input and output 75Ω terminated.
 Harmonics are measured with V<sub>IN</sub> = 1 V<sub>PP</sub>, A<sub>V</sub> = +2 and R<sub>L</sub> = 100Ω.



# 6.7 ±5V DC Electrical Characteristics

Unless otherwise noted, all limits are specified for V<sup>+</sup> = +5V, V<sup>-</sup> = -5V, V<sub>CM</sub> = 0V, and R<sub>L</sub> = 1 k $\Omega$ . **Boldface** limits apply at the temperature extremes

|                    | PARAMETER                                | TEST CONDITIONS                     | <b>TYP</b> <sup>(1)</sup> | LM7171AI<br>LIMIT <sup>(2)</sup> | LM7171BI<br>LIMIT <sup>(2)</sup> | UNIT  |
|--------------------|--|-------------------------------------|---------------------------|----------------------------------|----------------------------------|-------|
| V <sub>OS</sub>    | Input Offset Voltage                     |                                     | 0.3                       | 1.5                              | 3.5                              | mV    |
|                    |  |                                     |                           | 4                                | 7                                | max   |
| TC V <sub>OS</sub> | Input Offset Voltage Average<br>Drift    |                                     | 35                        |                                  |                                  | µV/°C |
| I <sub>B</sub>     | Input Bias Current                       |                                     | 3.3                       | 10                               | 10                               | μA    |
|                    |  |                                     |                           | 12                               | 12                               | max   |
| l <sub>os</sub>    | Input Offset Current                     |                                     | 0.1                       | 4                                | 4                                | μA    |
|                    |  |                                     |                           | 6                                | 6                                | max   |
| R <sub>IN</sub>    | Input Resistance                         | Common Mode                         | 40                        |                                  |                                  | MΩ    |
|                    |  | Differential Mode                   | 3.3                       |                                  |                                  |       |
| R <sub>O</sub>     | Output Resistance                        |                                     | 15                        |                                  |                                  | Ω     |
| CMRR               | Common Mode Rejection                    | $V_{CM} = \pm 2.5 V$                | 104                       | 80                               | 70                               | dB    |
|                    | Ratio                                    |                                     |                           | 75                               | 65                               | min   |
| PSRR Powe          | Power Supply Rejection Ratio             | $V_{\rm S} = \pm 15 V$ to $\pm 5 V$ | 90                        | 85                               | 75                               | dB    |
|                    |  |                                     |                           | 80                               | 70                               | min   |
| V <sub>СМ</sub>    | Input Common-Mode Voltage<br>Range       | CMRR > 60 dB                        | ±3.2                      |                                  |                                  | V     |
| A <sub>V</sub>     | Large Signal Voltage Gain <sup>(3)</sup> | $R_L = 1 k\Omega$                   | 78                        | 75                               | 70                               | dB    |
|                    |  |                                     |                           | 70                               | 65                               | min   |
|                    |  | $R_L = 100\Omega$                   | 76                        | 72                               | 68                               | dB    |
|                    |  |                                     |                           | 67                               | 63                               | min   |
| Vo                 | Output Swing                             | $R_L = 1 k\Omega$                   | 3.4                       | 3.2                              | 3.2                              | V     |
|                    |  |                                     |                           | 3                                | 3                                | min   |
|                    |  |                                     | -3.4                      | -3.2                             | -3.2                             | V     |
|                    |  |                                     |                           | -3                               | -3                               | max   |
|                    |  | R <sub>L</sub> = 100Ω               | 3.1                       | 2.9                              | 2.9                              | V     |
|                    |  |                                     |                           | 2.8                              | 2.8                              | min   |
|                    |  |                                     | -3.0                      | -2.9                             | -2.9                             | V     |
|                    |  |                                     |                           | -2.8                             | -2.8                             | max   |
|                    | Output Current (Open Loop)               | Sourcing, $R_L = 100\Omega$         | 31                        | 29                               | 29                               | mA    |
|                    | (4)                                      |                                     |                           | 28                               | 28                               | min   |
|                    |  | Sinking, $R_L = 100\Omega$          | 30                        | 29                               | 29                               | mA    |
|                    |  |                                     |                           | 28                               | 28                               | max   |
| I <sub>SC</sub>    | Output Short Circuit Current             | Sourcing                            | 135                       |                                  |                                  | mA    |
|                    |  | Sinking                             | 100                       |                                  |                                  |       |
| I <sub>S</sub>     | Supply Current                           |                                     | 6.2                       | 8                                | 8                                | mA    |
|                    |  |                                     |                           | 9                                | 9                                | max   |

(1) Typical values represent the most likely parametric norm.

(2)

All limits are specified by testing or statistical analysis. Large signal voltage gain is the total output swing divided by the input signal required to produce that swing. For  $V_S = \pm 15V$ ,  $V_{OUT} =$ (3)  $\pm$ 5V. For V<sub>S</sub> =  $\pm$ 5V, V<sub>OUT</sub> =  $\pm$ 1V.

(4) The open loop output current is specified, by the measurement of the open loop output voltage swing, using 100Ω output load.

EXAS ISTRUMENTS

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# 6.8 ±5V AC Electrical Characteristics

Unless otherwise noted, all limits are specified for V<sup>+</sup> = +5V, V<sup>-</sup> = -5V, V<sub>CM</sub> = 0V, and R<sub>L</sub> = 1 k $\Omega$ .

|                | PARAMETER                                 | TEST CONDITIONS  | TYP <sup>(1)</sup> | LM7171AI<br>LIMIT <sup>(2)</sup> | LM7171BI<br>LIMIT <sup>(2)</sup> | UNIT   |
|----------------|---|--|--------------------|----------------------------------|----------------------------------|--------|
| SR             | Slew Rate <sup>(3)</sup>                  | $A_V = +2, V_{IN} = 3.5 V_{PP}$  | 950                |                                  |                                  | V/µs   |
|                | Unity-Gain Bandwidth                      |  | 125                |                                  |                                  | MHz    |
|                | -3 dB Frequency                           | A <sub>V</sub> = +2  | 140                |                                  |                                  | MHz    |
| φ <sub>m</sub> | Phase Margin                              |  | 57                 |                                  |                                  | Deg    |
| t <sub>s</sub> | Settling Time (0.1%)                      | $\begin{array}{l} A_{V}=-1, \ V_{O}=\pm 1V,\\ R_{L}=500\Omega \end{array}$       | 56                 |                                  |                                  | ns     |
| t <sub>p</sub> | Propagation Delay                         | $\begin{array}{l} A_V = -2, \ V_{IN} = \pm 1 V, \\ R_L = 500 \Omega \end{array}$ | 6                  |                                  |                                  | ns     |
| A <sub>D</sub> | Differential Gain <sup>(4)</sup>          |  | 0.02%              |                                  |                                  |        |
| φ <sub>D</sub> | Differential Phase (5)                    |  | 0.03               |                                  |                                  | Deg    |
|                | Second Harmonic Distortion <sup>(6)</sup> | f <sub>IN</sub> = 10 kHz   | -102               |                                  |                                  | dBc    |
|                |   | f <sub>IN</sub> = 5 MHz  | -70                |                                  |                                  | dBc    |
|                | Third Harmonic Distortion <sup>(6)</sup>  | f <sub>IN</sub> = 10 kHz   | -110               |                                  |                                  | dBc    |
|                |   | f <sub>IN</sub> = 5 MHz  | -51                |                                  |                                  | dBc    |
| en             | Input-Referred Voltage Noise              | f = 10 kHz   | 14                 |                                  |                                  | nV/√Hz |
| i <sub>n</sub> | Input-Referred Current Noise              | f = 10 kHz   | 1.8                |                                  |                                  | pA/√Hz |

Typical values represent the most likely parametric norm. (1)

All limits are specified by testing or statistical analysis. (2)

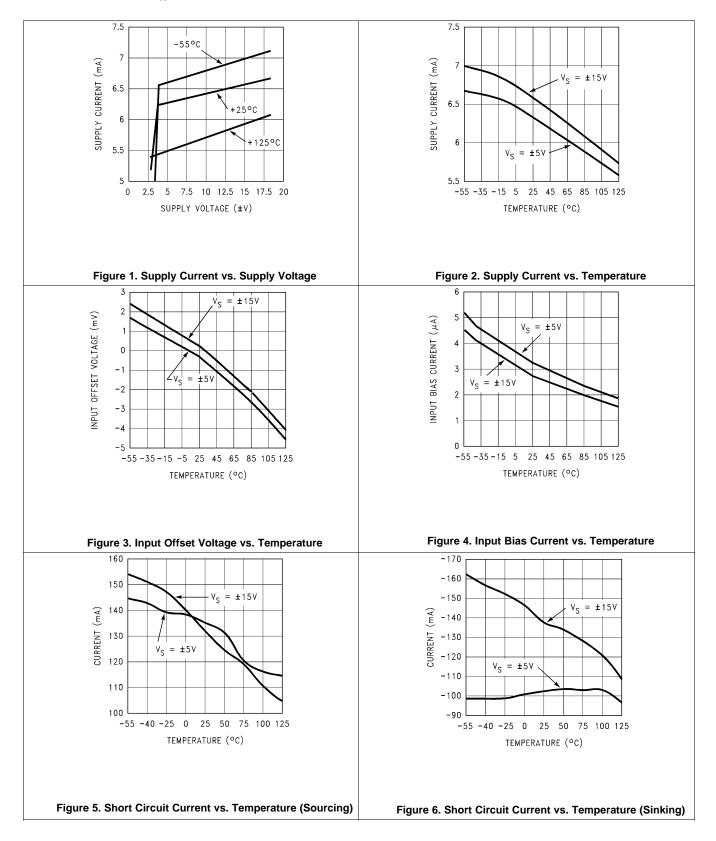
Slew Rate is the average of the raising and falling slew rates. Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for (3) (4) which the device is intended to be functional, but specific performance is not specified. For ensured specifications and the test conditions, see the Electrical Characteristics.

Differential gain and phase are measured with  $A_V = +2$ ,  $V_{IN} = 1 V_{PP}$  at 3.58 MHz and both input and output 75 $\Omega$  terminated. Harmonics are measured with  $V_{IN} = 1 V_{PP}$ ,  $A_V = +2$  and  $R_L = 100\Omega$ . (5) (6)



# 6.9 Typical Performance Characteristics

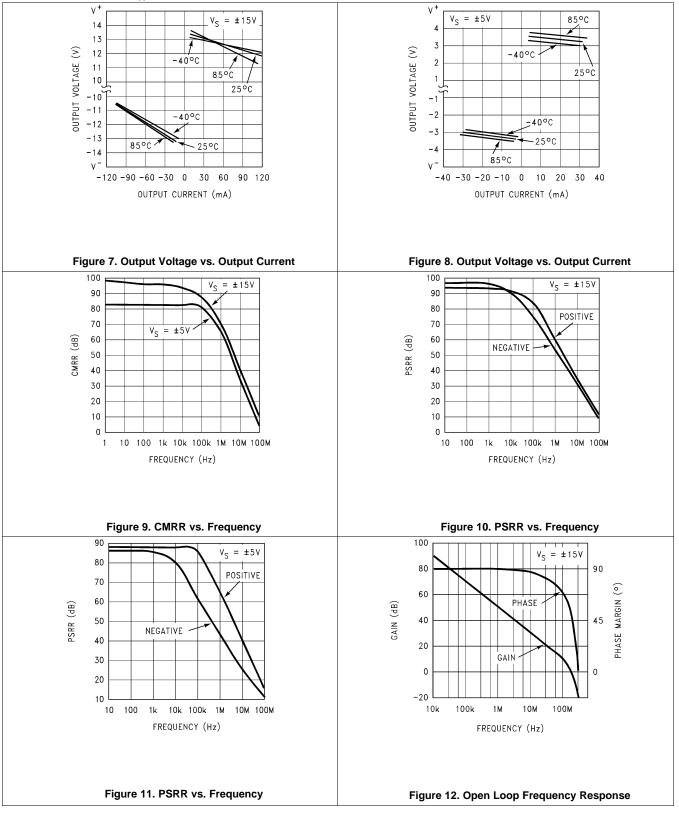
unless otherwise noted,  $T_A = 25^{\circ}C$ 





# **Typical Performance Characteristics (continued)**

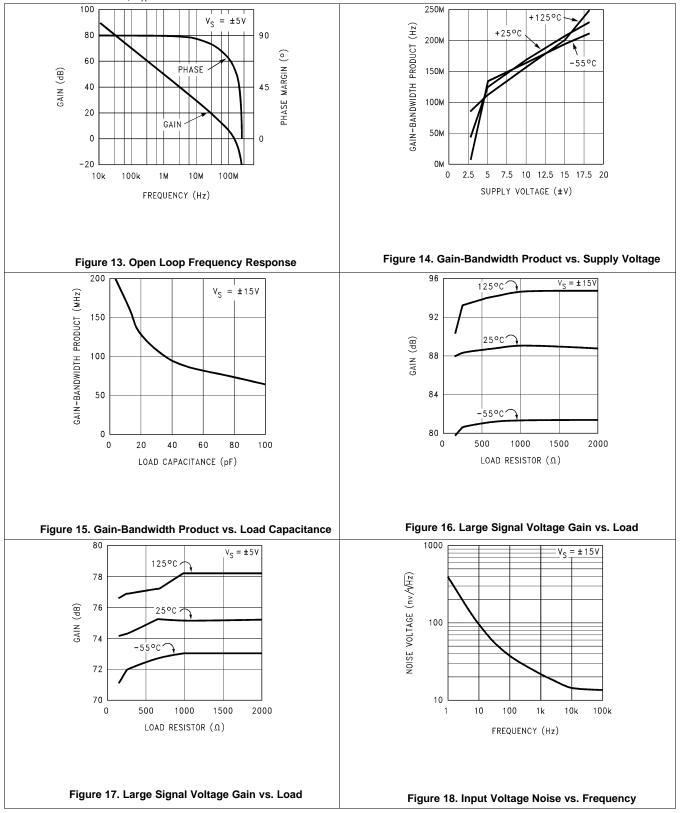
unless otherwise noted,  $T_A$ = 25°C





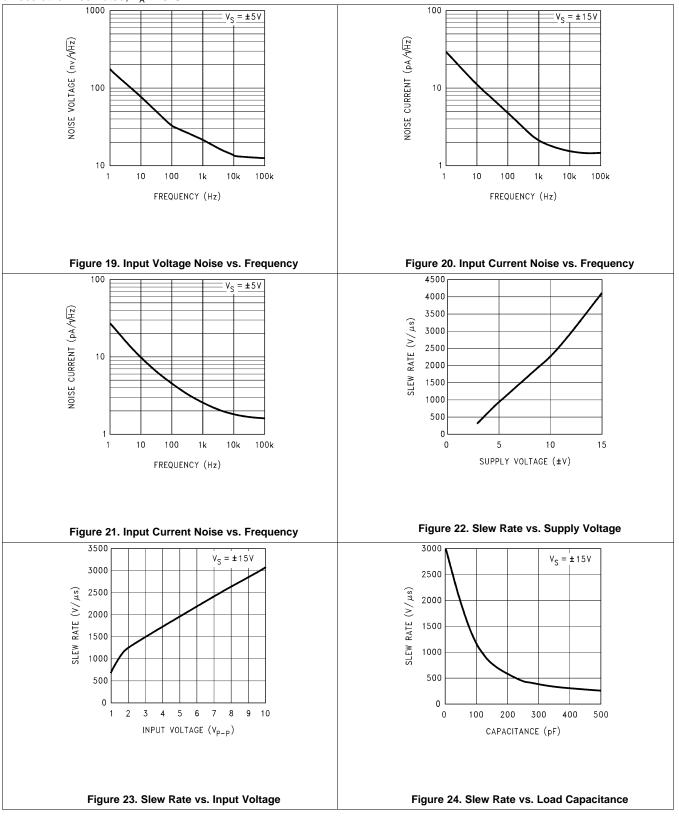
# **Typical Performance Characteristics (continued)**

unless otherwise noted,  $T_A$ = 25°C



# **Typical Performance Characteristics (continued)**

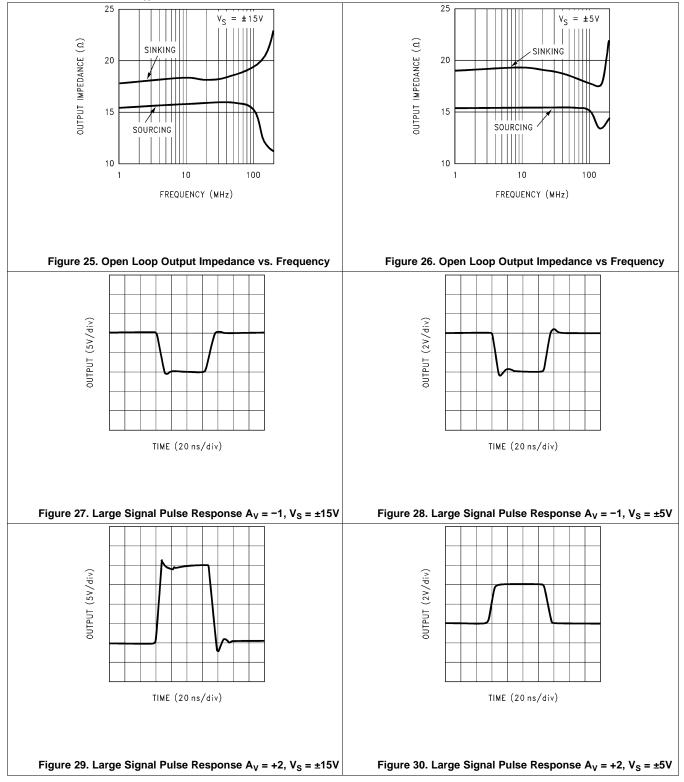
unless otherwise noted,  $T_A= 25^{\circ}C$ 



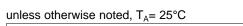


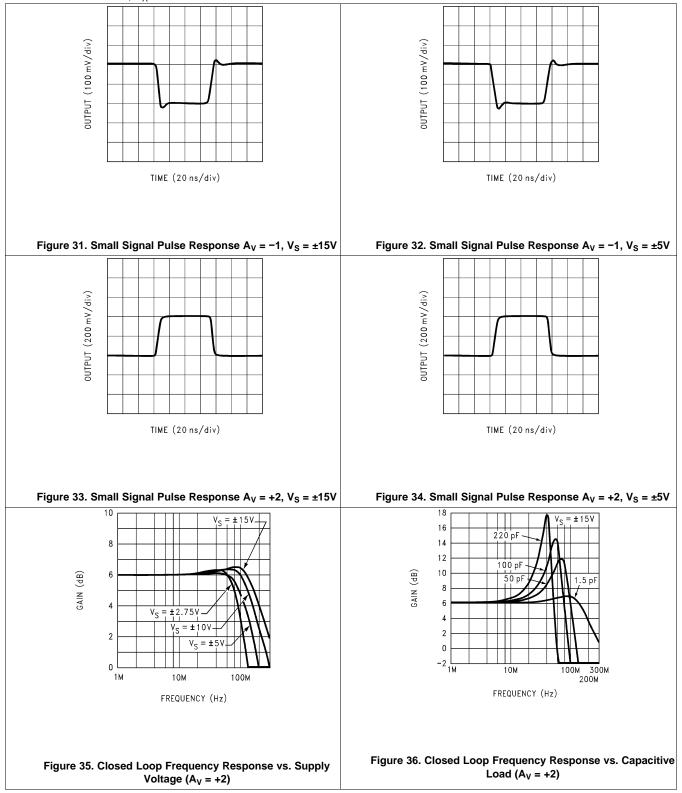
# **Typical Performance Characteristics (continued)**

unless otherwise noted,  $T_A= 25^{\circ}C$ 



# **Typical Performance Characteristics (continued)**

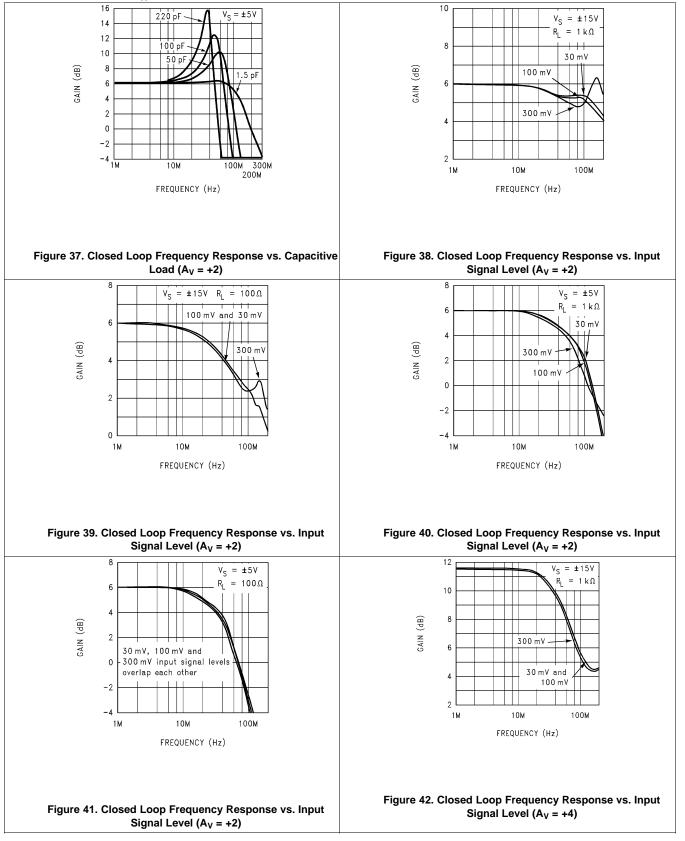






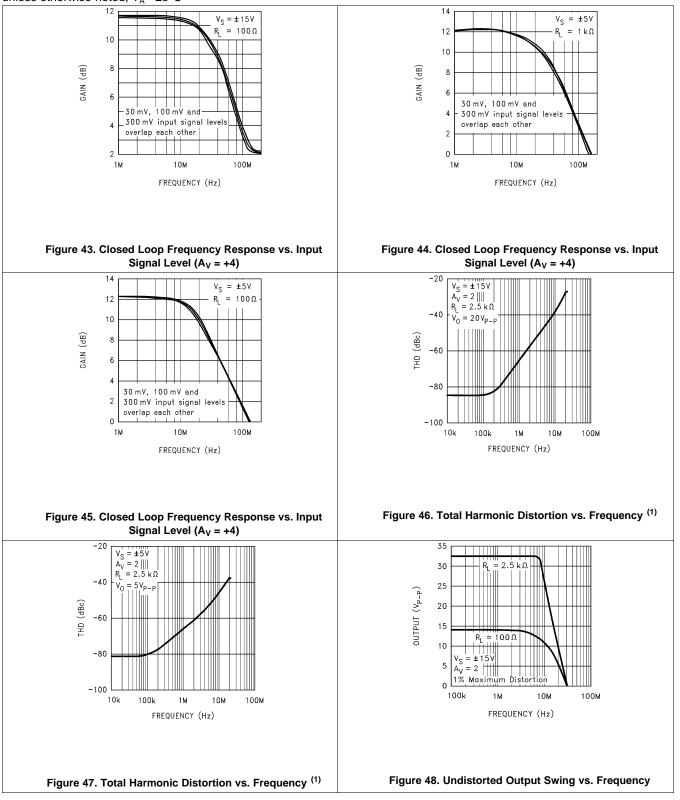
# **Typical Performance Characteristics (continued)**

unless otherwise noted,  $T_A= 25^{\circ}C$ 



# **Typical Performance Characteristics (continued)**

unless otherwise noted,  $T_A$ = 25°C



(1) The THD measurement at low frequency is limited by the test instrument.

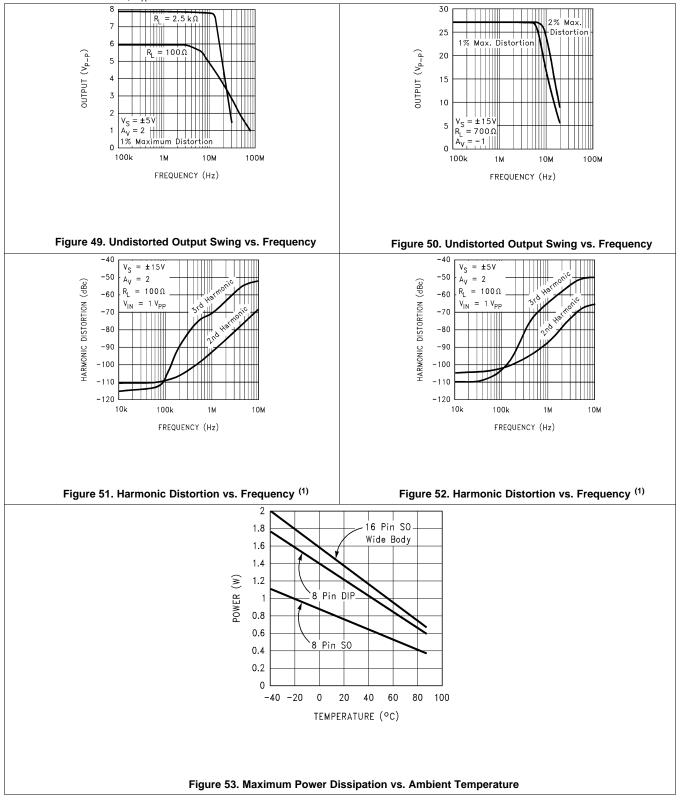
(1) The THD measurement at low frequency is limited by the test instrument.

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# **Typical Performance Characteristics (continued)**

unless otherwise noted,  $T_A$ = 25°C



The THD measurement at low frequency is limited by the test instrument. (1)

The THD measurement at low frequency is limited by the test instrument. (1)



# 7 Application and Implementation

# 7.1 Application Information

The LM7171 is a very high speed, voltage feedback amplifier. It consumes only 6.5 mA supply current while providing a unity-gain bandwidth of 200 MHz and a slew rate of 4100V/µs. It also has other great features such as low differential gain and phase and high output current.

The LM7171 is a true voltage feedback amplifier. Unlike current feedback amplifiers (CFAs) with a low inverting input impedance and a high non-inverting input impedance, both inputs of voltage feedback amplifiers (VFAs) have high impedance nodes. The low impedance inverting input in CFAs and a feedback capacitor create an additional pole that will lead to instability. As a result, CFAs cannot be used in traditional op amp circuits such as photodiode amplifiers, I-to-V converters and integrators where a feedback capacitor is required.

# 7.2 Circuit Operation

The class AB input stage in LM7171 is fully symmetrical and has a similar slewing characteristic to the current feedback amplifiers. In the LM7171 Simplified Schematic, Q1 through Q4 form the equivalent of the current feedback input buffer, R<sub>E</sub> the equivalent of the feedback resistor, and stage A buffers the inverting input. The triple-buffered output stage isolates the gain stage from the load to provide low output impedance.

# 7.3 Slew Rate Characteristic

The slew rate of LM7171 is determined by the current available to charge and discharge an internal high impedance node capacitor. This current is the differential input voltage divided by the total degeneration resistor  $R_E$ . Therefore, the slew rate is proportional to the input voltage level, and the higher slew rates are achievable in the lower gain configurations. A curve of slew rate versus input voltage level is provided in *Typical Performance Characteristics* 

When a very fast large signal pulse is applied to the input of an amplifier, some overshoot or undershoot occurs. By placing an external resistor such as 1 k $\Omega$  in series with the input of LM7171, the bandwidth is reduced to help lower the overshoot.

# 7.4 Slew Rate Limitation

If the amplifier's input signal has too large of an amplitude at too high of a frequency, the amplifier is said to be slew rate limited; this can cause ringing in time domain and peaking in frequency domain at the output of the amplifier.

In *Typical Performance Characteristics*, there are several curves of  $A_V = +2$  and  $A_V = +4$  versus input signal levels. For the  $A_V = +4$  curves, no peaking is present and the LM7171 responds identically to the different input signal levels of 30 mV, 100 mV and 300 mV.

For the  $A_V = +2$  curves, with slight peaking occurs. This peaking at high frequency (>100 MHz) is caused by a large input signal at high enough frequency that exceeds the amplifier's slew rate. The peaking in frequency response does not limit the pulse response in time domain, and the LM7171 is stable with noise gain of ≥+2.



(1)

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## 7.5 Compensation For Input Capacitance

The combination of an amplifier's input capacitance with the gain setting resistors adds a pole that can cause peaking or oscillation. To solve this problem, a feedback capacitor with a value

 $C_F > (R_G \times C_{IN})/R_F$ 

can be used to cancel that pole. For LM7171, a feedback capacitor of 2 pF is recommended. Figure 54 illustrates the compensation circuit.

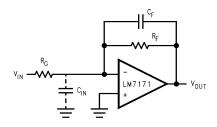
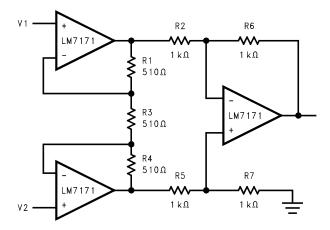
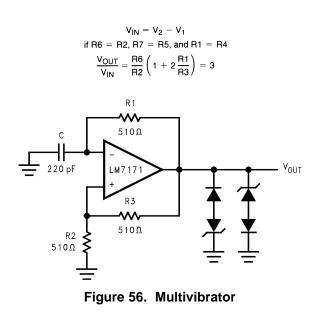


Figure 54. Compensating for Input Capacitance

# 7.6 Application Circuit







# Application Circuit (continued)

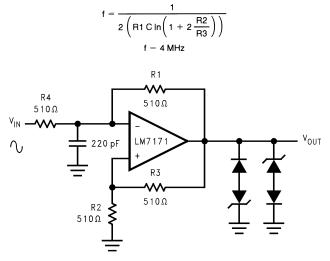


Figure 57. Pulse Width Modulator

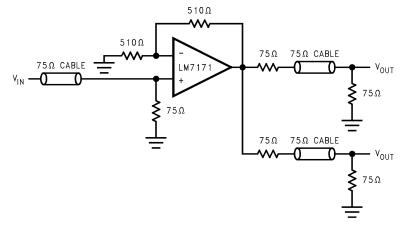


Figure 58. Video Line Driver



# 8 Power Supply Recommendations

# 8.1 Power Supply Bypassing

Bypassing the power supply is necessary to maintain low power supply impedance across frequency. Both positive and negative power supplies should be bypassed individually by placing 0.01  $\mu$ F ceramic capacitors directly to power supply pins and 2.2  $\mu$ F tantalum capacitors close to the power supply pins.

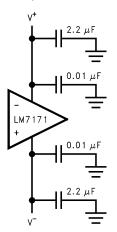


Figure 59. Power Supply Bypassing



# 8.2 Termination

In high frequency applications, reflections occur if signals are not properly terminated. Figure 60 shows a properly terminated signal while Figure 61 shows an improperly terminated signal.

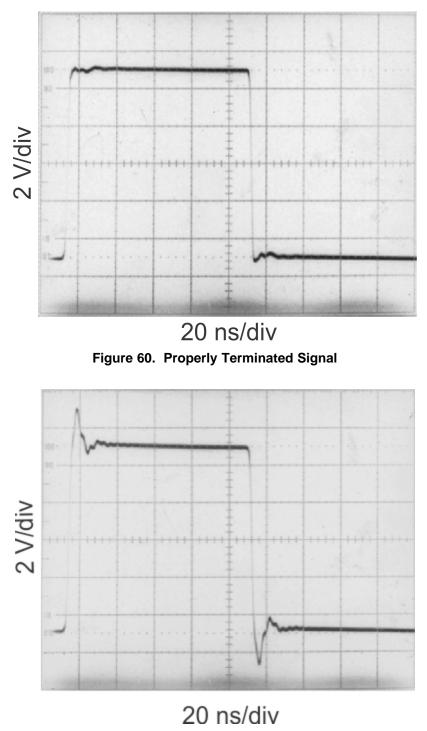


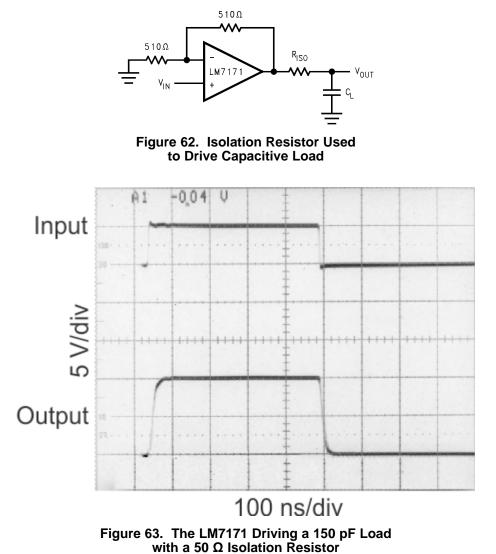
Figure 61. Improperly Terminated Signal

To minimize reflection, coaxial cable with matching characteristic impedance to the signal source should be used. The other end of the cable should be terminated with the same value terminator or resistor. For the commonly used cables, RG59 has  $75\Omega$  characteristic impedance, and RG58 has  $50\Omega$  characteristic impedance.



# 8.3 Driving Capacitive Loads

Amplifiers driving capacitive loads can oscillate or have ringing at the output. To eliminate oscillation or reduce ringing, an isolation resistor can be placed as shown in Figure 62. The combination of the isolation resistor and the load capacitor forms a pole to increase stability by adding more phase margin to the overall system. The desired performance depends on the value of the isolation resistor; the bigger the isolation resistor, the more damped the pulse response becomes. For LM7171, a 50 $\Omega$  isolation resistor is recommended for initial evaluation. Figure 63 shows the LM7171 driving a 150 pF load with the 50 $\Omega$  isolation resistor.



## 8.4 Power Dissipation

The maximum power allowed to dissipate in a device is defined as:

 $P_{\rm D} = (T_{\rm J(MAX)} - T_{\rm A})/\theta_{\rm JA}$ 

where

- PD is the power dissipation in a device
- T<sub>J(max)</sub> is the maximum junction temperature
- T<sub>A</sub> is the ambient temperature
- R<sub>0JA</sub> is the thermal resistance of a particular package
- •

(2)

For example, for the LM7171 in a SOIC-8 package, the maximum power dissipation at 25°C ambient temperature is 730 mW.

Thermal resistance, R  $_{\theta JA}$ , depends on parameters such as die size, package size and package material. The smaller the die size and package, the higher R $_{\theta JA}$  becomes. The 8-pin DIP package has a lower thermal resistance (108°C/W) than that of 8-pin SOIC (172°C/W). Therefore, for higher dissipation capability, use an 8-pin DIP package.

The total power dissipated in a device can be calculated as:

 $P_D = P_Q + P_L$ 

where

• P<sub>Q</sub> is the quiescent power dissipated in a device with no load connected at the output. P<sub>L</sub> is the power dissipated in the device with a load connected at the output; it is not the power dissipated by the load.

Furthermore,

- P<sub>Q</sub>is the supply current × total supply voltage with no load
- P<sub>L</sub> is the output current × (voltage difference between supply voltage and output voltage of the same side of supply voltage)
  (3)

For example, the total power dissipated by the LM7171 with  $V_s = \pm 15V$  and output voltage of 10V into 1 k $\Omega$  is

| • •                     |             | •          | ,      | 0 |  | 0 |     |
|-------------------------|-------------|------------|--------|---|--|---|-----|
| $P_{D} = P_{Q} + P_{L}$ |             |            |        |   |  |   | (4) |
| = (6.5 mA) × (30        | )V) + (10 r | nA) × (15V | – 10V) |   |  |   | (5) |
| = 195 mW + 50           | mW          |            |        |   |  |   | (6) |
| = 245 mW                |             |            |        |   |  |   | (7) |



# 9 Layout

# 9.1 Layout Guidelines

## 9.1.1 Printed Circuit Board and High Speed Op Amps

There are many things to consider when designing PC boards for high speed op amps. Without proper caution, it is very easy to have excessive ringing, oscillation and other degraded AC performance in high speed circuits. As a rule, the signal traces should be short and wide to provide low inductance and low impedance paths. Any unused board space needs to be grounded to reduce stray signal pickup. Critical components should also be grounded at a common point to eliminate voltage drop. Sockets add capacitance to the board and can affect high frequency performance. It is better to solder the amplifier directly into the PC board without using any socket.

## 9.1.2 Using Probes

Active (FET) probes are ideal for taking high frequency measurements because they have wide bandwidth, high input impedance and low input capacitance. However, the probe ground leads provide a long ground loop that will produce errors in measurement. Instead, the probes can be grounded directly by removing the ground leads and probe jackets and using scope probe jacks.

## 9.1.3 Component Selection and Feedback Resistor

It is important in high speed applications to keep all component leads short. For discrete components, choose carbon composition-type resistors and mica-type capacitors. Surface mount components are preferred over discrete components for minimum inductive effect.

Large values of feedback resistors can couple with parasitic capacitance and cause undesirable effects such as ringing or oscillation in high speed amplifiers. For LM7171, a feedback resistor of  $510\Omega$  gives optimal performance.

# NSTRUMENTS

EXAS

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# **10** Device and Documentation Support

# 10.1 Trademarks

VIP is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

# **10.2 Electrostatic Discharge Caution**



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

# 10.3 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

# 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



# PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package | Pins | Package | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|---------|----------------------------|------------------|--------------------|--------------|----------------|---------|
|                  | (1)    |              | Drawing |      | Qty     | (2)                        | (6)              | (3)                |              | (4/5)          |         |
| LM7171AIM        | NRND   | SOIC         | D       | 8    | 95      | TBD                        | Call TI          | Call TI            | -40 to 85    | LM71<br>71AIM  |         |
| LM7171AIM/NOPB   | ACTIVE | SOIC         | D       | 8    | 95      | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 85    | LM71<br>71AIM  | Samples |
| LM7171AIMX/NOPB  | ACTIVE | SOIC         | D       | 8    | 2500    | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 85    | LM71<br>71AIM  | Samples |
| LM7171BIM        | NRND   | SOIC         | D       | 8    | 95      | TBD                        | Call TI          | Call TI            | -40 to 85    | LM71<br>71BIM  |         |
| LM7171BIM/NOPB   | ACTIVE | SOIC         | D       | 8    | 95      | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 85    | LM71<br>71BIM  | Samples |
| LM7171BIMX/NOPB  | ACTIVE | SOIC         | D       | 8    | 2500    | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 85    | LM71<br>71BIM  | Samples |
| LM7171BIN/NOPB   | ACTIVE | PDIP         | Р       | 8    | 40      | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-NA-UNLIM   | -40 to 85    | LM7171<br>BIN  | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



# PACKAGE OPTION ADDENDUM

19-Mar-2015

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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# PACKAGE MATERIALS INFORMATION

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# TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |   |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| LM7171AIMX/NOPB             | SOIC            | D                  | 8 | 2500 | 330.0                    | 12.4                     | 6.5        | 5.4        | 2.0        | 8.0        | 12.0      | Q1               |
| LM7171BIMX/NOPB             | SOIC            | D                  | 8 | 2500 | 330.0                    | 12.4                     | 6.5        | 5.4        | 2.0        | 8.0        | 12.0      | Q1               |

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# PACKAGE MATERIALS INFORMATION

5-Dec-2014



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM7171AIMX/NOPB | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| LM7171BIMX/NOPB | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |

P(R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.



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